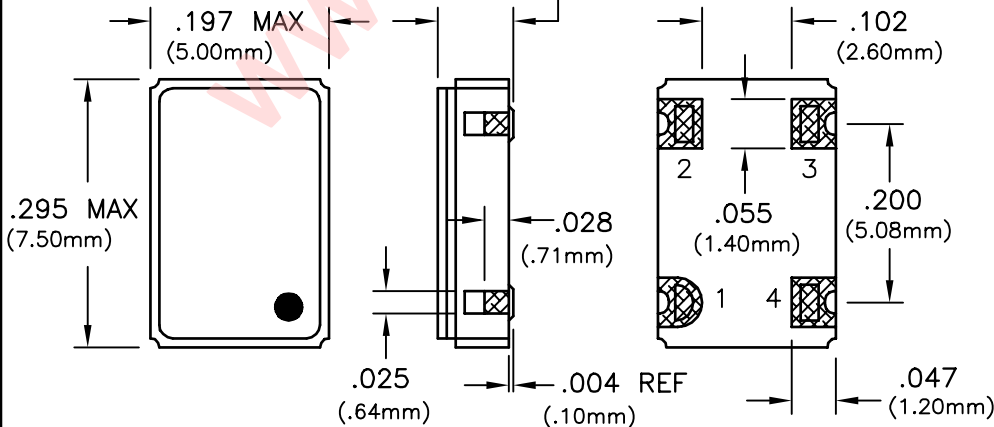


3.3V TRI-STATE HCMOS SMD OSCILLATOR

| SPECIFICATIONS | | HSM633 | | |
|--|-----------------|---|-----------------------------------|--|
| Frequency Range | | 1.8432MHz to 67MHz | | |
| Frequency Stability | | ±100ppm <small>(Inclusive of calibration tolerance at 25°C, operating temperature range, supply voltage change, load change, aging, shock and vibration)</small> | | |
| Temperature Range | | -40°C to +85°C | | |
| Output | Waveform | HCMOS Squarewave | | |
| | Load | 15pF | | |
| | Voltage | Voh | 2.9V Minimum | |
| | | Vol | 0.33V Maximum | |
| | Current | Ioh | -2mA | |
| | | Iol | 2mA | |
| | Duty Cycle | 45/55 Typical measured @ 50% of Vdd | | |
| Rise/Fall Time | 6nS Maximum | | | |
| Jitter | 5pS RMS Maximum | | | |
| Input | Output E/D Time | Enable 10mS Maximum , Disable 150nS Maximum | | |
| | Enable | Vih | ≥ 70% Vdd Minimum (Output Active) | |
| | Disable | Vil | ≤ 30% Vdd Maximum (Output High z) | |
| Oscillator output is enabled with no connection on pin 1 | | | | |
| Start Up Time | | 10mS Maximum | | |
| Supply Voltage (Vdd) | | +3.3Vdc ±0.3Vdc | | |
| Supply Current | | 18mA Maximum | | |

Dimensional Tolerance: .005 (.13mm)
.060 MAX (1.50mm)



| PIN | CONNECTION |
|-----|---------------|
| 1 | TRI-STATE E/D |
| 2 | GROUND |
| 3 | OUTPUT |
| 4 | VDD |

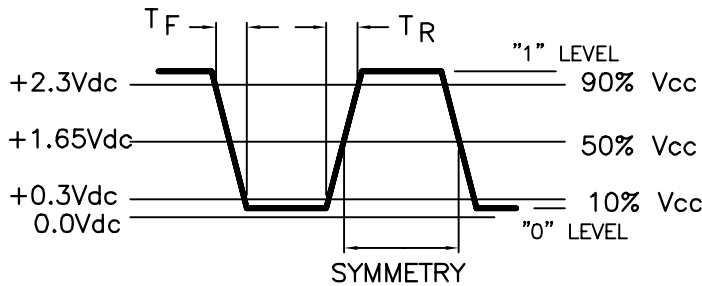
ORDERING INFORMATION

HSM633 - 50.00MHz

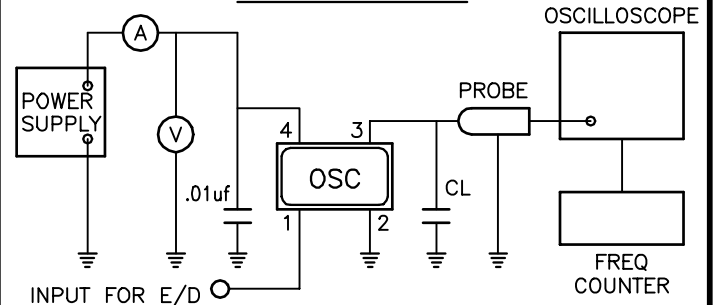
CLOCK
SERIES

CENTER
FREQUENCY

OUTPUT WAVEFORM



TEST CIRCUIT



MECHANICAL CHARACTERISTICS

FREE DROP:

The specimen shall meet electrical characteristics after tested 3 times Free Drop testing on the hard wooden board from a height of 75cm.

VIBRATION:

The specimen shall meet electrical characteristics after tested by the following conditions; 10-55Hz 1.5mm Amplitude, 55-2000Hz 20G's, 2 hours for each plane.

THERMAL SHOCK:

After applied Thermal Shock of 260 C max x 10 sec max x 2 times, or 230 C max x 180 sec max, the specimen shall meet electrical characteristics.

SOLDERABILITY: (EIAJ-RCX-0102/101 Condition 1a)

1. Flux: ML-F-14256 (WW Rosin=25%, Isopropyl alcohol=75%)
2. Solder: QQ-S-571 (Sn=63%, Pb=37%)
3. Solder bath temperature: 235 C +/-5 C.
4. Depth of immersion: Up to electrical terminal.
5. Immersing time: Within 2 sec +/-0.5 sec into solder bath.

After performing the above procedures, a newly soldered coverage shall be greater than 90%.

ENVIRONMENTAL CHARACTERISTICS

TEMPERATURE CYCLE:

The specimen shall meet electrical characteristics after tested 5 cycles of -55 C/30 min & +125 C/30 min.

HERMETICAL

No bubbles appear in Flourinert (FC-43) at 125 C +/-5 C, for 5 minutes.

SOLVENT RESISTANCE:

Marking will withstand immersion in Isopropyl Alcohol or Trichloroethylene.

SOLDERING

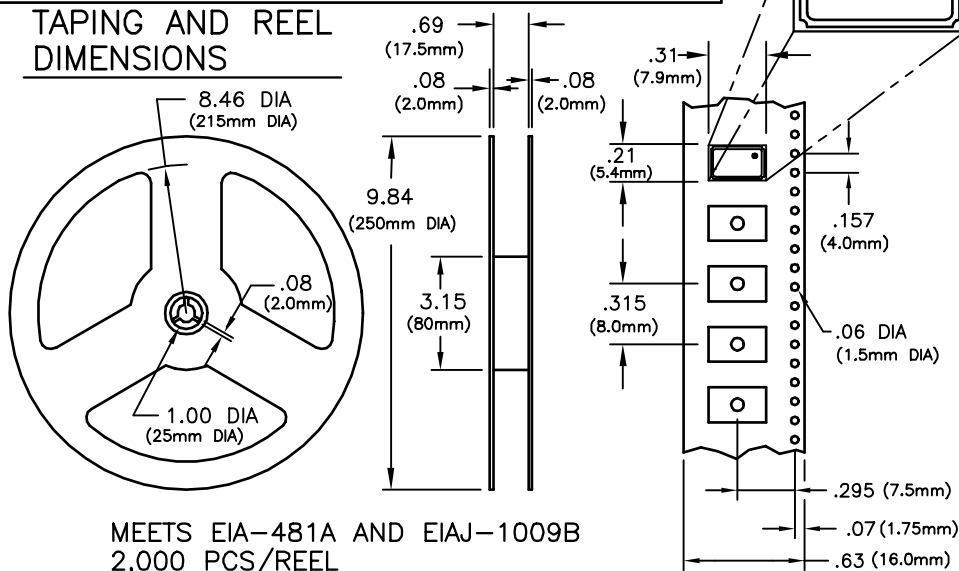
GENERAL CONDITIONS:

260°C max x 10 sec max x 2 times max or 230°C max x 180 sec max x 1 time.

TYPICAL OPERATION DATA (Vapor phase reflow)

20 to 100 sec up to 215°C, 50 sec at 215°C then down to room temperature per 1 to 5°C/sec

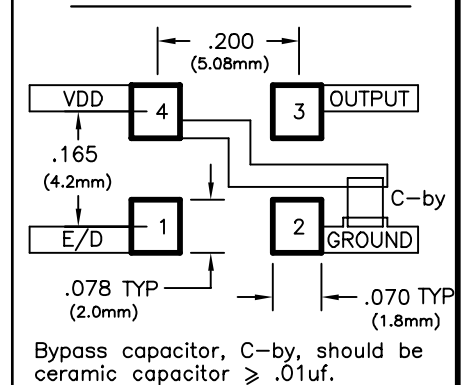
TAPING AND REEL DIMENSIONS



MEETS EIA-481A AND EIAJ-1009B
2,000 PCS/REEL

PIN 1

SUGGESTED PAD LAYOUT



Bypass capacitor, C-by, should be ceramic capacitor \geq .01uf.